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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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2SD768(K)

Silicon NPN Epitaxial

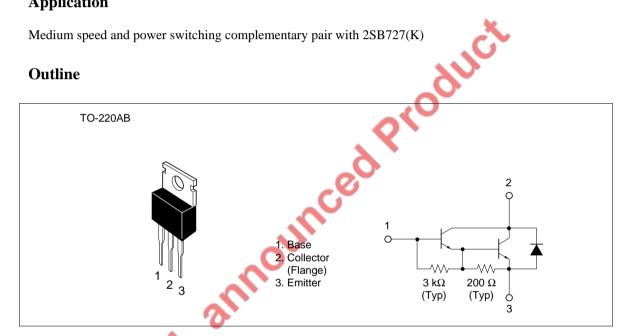


ADE-208-900 (Z) 1st. Edition September 2000

Application

Medium speed and power switching complementary pair with 2SB727(K)

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

| Item | Symbol | Ratings | Unit | |
|------------------------------|----------------------------------|-------------|------|--|
| Collector to base voltage | $V_{\scriptscriptstyle \sf CBO}$ | 120 | V | |
| Collector to emitter voltage | V _{CEO} | 120 | V | |
| Emitter to base voltage | V_{EBO} | 7 | V | |
| Collector current | I _c | 6 | А | |
| Collector peak current | I _{C(peak)} | 10 | А | |
| Collector power dissipation | Pc*1 | 40 | W | |
| Junction temperature | Tj | 150 | °C | |
| Storage temperature | Tstg | -55 to +150 | °C | |

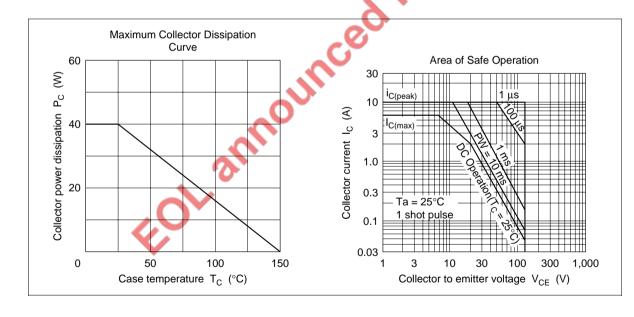
Note: 1. Value at $T_c = 25^{\circ}C$.

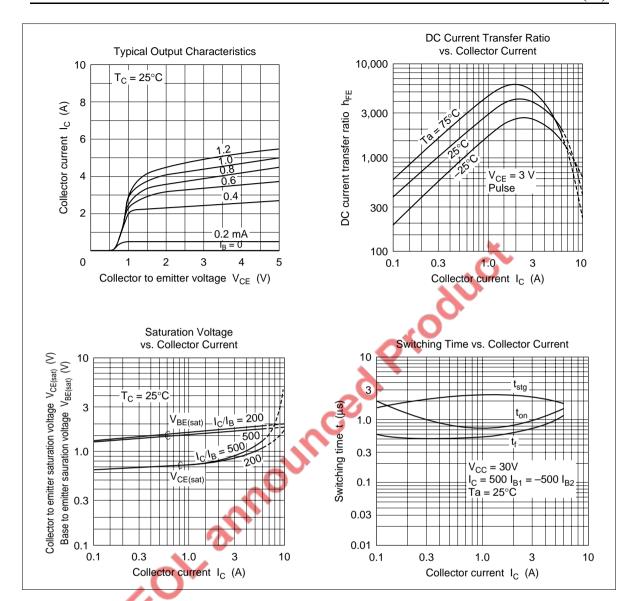
2SD768(K)

Electrical Characteristics ($Ta = 25^{\circ}C$)

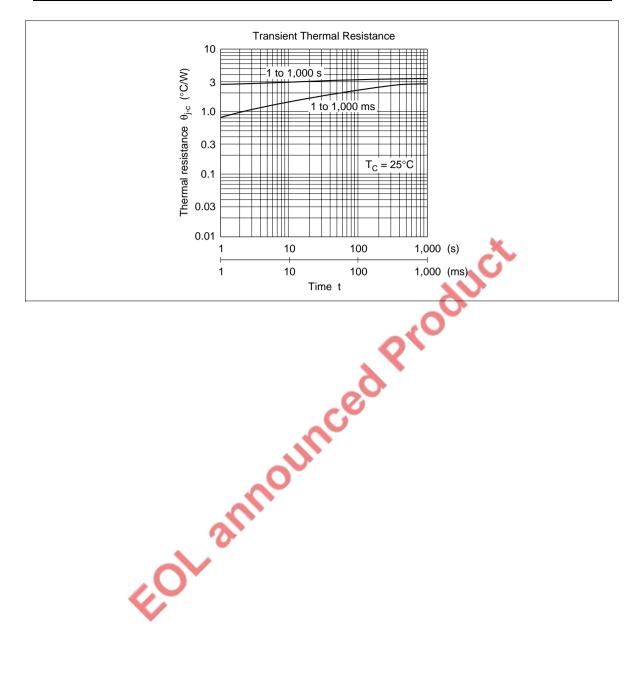
| Item | Symbol | Min | Тур | Max | Unit | Test conditions |
|--|------------------------------|------|-----|-------|------|--|
| Collector to emitter breakdown voltage | $V_{(BR)CEO}$ | 120 | _ | _ | V | I_{C} = 25 mA, R_{BE} = ∞ |
| Emitter to base breakdown voltage | $V_{(BR)EBO}$ | 7 | _ | _ | V | $I_{E} = 50 \text{ mA}, I_{C} = 0$ |
| Collector cutoff current | I _{CBO} | _ | _ | 100 | μΑ | V _{CB} = 120 V, I _E = 0 |
| | I _{CEO} | _ | _ | 10 | μΑ | V _{CE} = 100 V, R _{BE} =∞ |
| DC current transfer ratio | h _{FE} | 1000 | _ | 20000 | | $V_{CE} = 3 \text{ V}, I_{C} = 3 \text{ A}^{*1}$ |
| Collector to emitter saturation | V _{CE(sat)1} | _ | _ | 1.5 | V | $I_{\rm C} = 3 \text{ A}, I_{\rm B} = 6 \text{ mA}^{*1}$ |
| voltage | $V_{\text{CE}(\text{sat})2}$ | _ | _ | 3 | V | $I_{\rm C} = 6A$, $I_{\rm B} = 60 \text{ mA}^{*1}$ |
| Base to emitter saturation | $V_{\text{BE}(\text{sat})1}$ | _ | _ | 2 | V | $I_{\rm C} = 3 \text{ A}, I_{\rm B} = 6 \text{ mA}^{*1}$ |
| voltage | $V_{BE(sat)2}$ | _ | _ | 3.5 | V | $I_{c} = 6 \text{ A}, I_{B} = 60 \text{ mA}^{*1}$ |
| Turn on time | t _{on} | _ | 1.0 | _ | μs | $I_c = 3 \text{ A}, I_{B1} = -I_{B2} = 6 \text{ mA}$ |
| Turn off time | t _{off} | _ | 3.0 | _ | μs | $I_{\rm C} = 3 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 6 \text{ mA}$ |

Note: 1. Pulse test.





2SD768(K)



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